

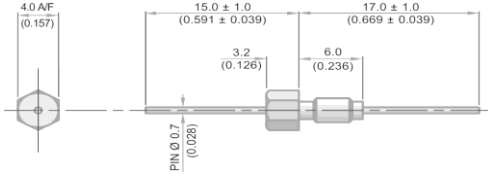
Feedthrough EMI Filter Datasheet

(6-32 UNC Thread : 4.0mm Hexagonal Head)

Circuit Configurations Available



Dimensions mm (inches)



6-32 UNC Class 2A Thread

| Electrical Details | |
|------------------------------|--|
| Electrical Configuration | C Filter |
| Capacitance Measurement | @ 1000hr Point |
| Current Rating | 10A |
| Insulation Resistance (IR) | 10GΩ or 1000ΩF |
| Temperature Rating | -55°C to +125°C |
| Ferrite Inductance (Typical) | See relevant tables |
| Mechanical Details | |
| Head A/F | 4mm (0.157") |
| Nut A/F | 4.75mm (0.187") |
| Washer Diameter | 6.9mm (0.272") |
| Mounting Torque | 0.3Nm (2.65lbf in) max. if using nut 0.15Nm (1.32lbf in) max. into tapped hole |
| Mounting Hole Diameter | 3.7mm ± 0.1 (0.146" ± 0.004") |
| Max. Panel Thickness | 3.2mm (0.126") |
| Weight (Typical) | 0.6g (0.02oz) |
| Finish | Silver plate on copper undercoat |

C Configuration

| Product Code | Hardware (Nuts & Washers etc.) | Capacitance ± 20% UOS | Dielectric | Rated Voltage (dc) | DWV (dc) | Typical Insertion Loss (db) | | | | | | |
|-----------------|--|-----------------------|------------|--------------------|----------|-----------------------------|--------|------|-------|--------|------|----|
| | | | | | | 0.01MHz | 0.1MHz | 1MHz | 10MHz | 100MHz | 1GHz | |
| *SFABC5000100ZC | 0 = No hardware supplied 1 = supplied with standard nut and wavy washer Other options available – please contact factory | 10pF -20% / +80% | COG | 500# | 750 | | | | | | 4 | |
| SFABC5000150ZC | | 15pF -20% / +80% | COG | 500# | 750 | | | | | | 7 | |
| SFABC5000220ZC | | 22pF -20% / +80% | COG | 500# | 750 | | | | | | 10 | |
| SFABC5000330ZC | | 33pF -20% / +80% | COG | 500# | 750 | | | | | | 12 | |
| *SFABC5000470ZC | | 47pF -20% / +80% | COG | 500# | 750 | | | | | 1 | 15 | |
| *SFABC5000680MC | | 68pF | COG | 500# | 750 | | | | | 2 | 18 | |
| *SFABC5000101MC | | 100pF | COG | 500# | 750 | | | | | 4 | 22 | |
| SFABC5000151MC | | 150pF | COG | 500# | 750 | | | | | 7 | 25 | |
| *SFABC5000221MC | | 220pF | COG | 500# | 750 | | | | | 10 | 29 | |
| *SFABC5000331MC | | 330pF | COG | 500# | 750 | | | | | 13 | 33 | |
| *SFABC5000471MX | | 470pF | † X7R | 500# | 750 | | | | 1 | 16 | 35 | |
| SFABC5000681MX | | 680pF | † X7R | 500# | 750 | | | | 2 | 19 | 36 | |
| *SFABC5000102MX | | 1.0nF | X7R | 500# | 750 | | | | 4 | 23 | 41 | |
| SFABC5000152MX | | 1.5nF | X7R | 500# | 750 | | | | 7 | 26 | 45 | |
| *SFABC5000222MX | | 2.2nF | X7R | 500# | 750 | | | | 10 | 30 | 50 | |
| SFABC5000332MX | | 3.3nF | X7R | 500# | 750 | | | | 13 | 33 | 52 | |
| *SFABC5000472MX | | 4.7nF | X7R | 500# | 750 | | | | 1 | 16 | 36 | 55 |
| SFABC5000682MX | | 6.8nF | X7R | 500# | 750 | | | | 2 | 19 | 39 | 57 |
| *SFABC5000103MX | | 10nF | X7R | 500# | 750 | | | | 4 | 22 | 41 | 60 |
| *SFABC5000153MX | | 15nF | X7R | 500# | 750 | | | | 7 | 25 | 44 | 62 |
| *SFABC5000223MX | 22nF | X7R | 500# | 750 | | | | 10 | 29 | 46 | 65 | |
| SFABC5000333MX | 33nF | X7R | 500# | 750 | | | | 13 | 33 | 48 | 68 | |
| *SFABC2000473MX | 47nF | X7R | 200 | 500 | | | 1 | 16 | 35 | 50 | 70 | |
| SFABC2000683MX | 68nF | X7R | 200 | 500 | | | 2 | 19 | 39 | 54 | >70 | |
| *SFABC1000104MX | 100nF | X7R | 100 | 250 | | | 4 | 22 | 41 | 57 | >70 | |
| *SFABC0500154MX | 150nF | X7R | 50 | 125 | | | 7 | 25 | 45 | 60 | >70 | |

- Also rated for operation at 115Vac 400Hz. Self-heating will occur – evaluation in situ recommended

* Recommended values

† Also available in COG



L-C Configuration

| Ferrite Inductance (Typical) - 50nH | | | | | | Typical Insertion Loss (db) | | | | | | |
|-------------------------------------|--|--------------------------|------------|-----------------------|-------------|-----------------------------|--------|-------|-------|--------|------|----|
| Product Code | Hardware | Capacitance ± 20% UOS | Dielectric | Rated Voltage (dc) | DWV (dc) | 0.01MHz | 0.1MHz | 1 MHz | 10MHz | 100MHz | 1GHz | |
| *SFABL5000100ZC | 0 = No hardware supplied 1 = supplied with standard nut and wavy washer Other options available – please contact factory | 10pF -20% / +80% | COG | 500# | 750 | | | | | | 6 | |
| SFABL5000150ZC | | 15pF -20% / +80% | COG | 500# | 750 | | | | | | 9 | |
| SFABL5000220ZC | | 22pF -20% / +80% | COG | 500# | 750 | | | | | | 12 | |
| SFABL5000330ZC | | 33pF -20% / +80% | COG | 500# | 750 | | | | | | 1 | 15 |
| *SFABL5000470ZC | | 47pF -20% / +80% | COG | 500# | 750 | | | | | | 2 | 19 |
| *SFABL5000680MC | | 68pF | COG | 500# | 750 | | | | | | 4 | 20 |
| *SFABL5000101MC | | 100pF | COG | 500# | 750 | | | | | | 7 | 24 |
| SFABL5000151MC | | 150pF | COG | 500# | 750 | | | | | | 10 | 27 |
| *SFABL5000221MC | | 220pF | COG | 500# | 750 | | | | | | 12 | 30 |
| *SFABL5000331MC | | 330pF | COG | 500# | 750 | | | | | 1 | 16 | 34 |
| *SFABL5000471MX | | 470pF | † X7R | 500# | 750 | | | | | 2 | 19 | 38 |
| SFABL5000681MX | | 680pF | † X7R | 500# | 750 | | | | | 3 | 22 | 41 |
| *SFABL5000102MX | | 1.0nF | X7R | 500# | 750 | | | | | 6 | 25 | 44 |
| SFABL5000152MX | | 1.5nF | X7R | 500# | 750 | | | | | 9 | 29 | 48 |
| *SFABL5000222MX | | 2.2nF | X7R | 500# | 750 | | | | | 12 | 31 | 51 |
| SFABL5000332MX | | 3.3nF | X7R | 500# | 750 | | | | | 15 | 35 | 54 |
| *SFABL5000472MX | | 4.7nF | X7R | 500# | 750 | | | | 1 | 18 | 39 | 57 |
| SFABL5000682MX | | 6.8nF | X7R | 500# | 750 | | | | 2 | 21 | 41 | 60 |
| *SFABL5000103MX | | 10nF | X7R | 500# | 750 | | | | 4 | 23 | 43 | 63 |
| *SFABL5000153MX | | 15nF | X7R | 500# | 750 | | | | 7 | 27 | 46 | 66 |
| *SFABL5000223MX | | 22nF | X7R | 500# | 750 | | | | 10 | 30 | 48 | 68 |
| SFABL5000333MX | | 33nF | X7R | 500# | 750 | | | | 13 | 34 | 50 | 70 |
| *SFABL2000473MX | | 47nF | X7R | 200 | 500 | | 1 | 17 | 37 | 51 | >70 | |
| SFABL2000683MX | | 68nF | X7R | 200 | 500 | | 2 | 20 | 40 | 55 | >70 | |
| *SFABL1000104MX | | 100nF | X7R | 100 | 250 | | 4 | 22 | 44 | 60 | >70 | |
| *SFABL0500154MX | | 150nF | X7R | 50 | 125 | | 7 | 25 | 47 | 62 | >70 | |

- Also rated for operation at 115Vac 400Hz. Self-heating will occur – evaluation in situ recommended

* Recommended values

† Also available in COG

Ordering Information

| Type | Case Style | Thread | Electrical configuration | Voltage (dc) | Capacitance in picofarads (pF) | Capacitance Tolerance | Dielectric | Hardware |
|--------------|-------------------|----------|--------------------------------|---|--|--------------------------|------------------------|-------------------------|
| SF | A | B | C | 500 | 0102 | M | X | 0 |
| Syfer Filter | 4.0mm Hex Head | 6-32 UNC | C = C Filter L = L-C Filter | 050 = 50V 100 = 100V 200 = 200V 500 = 500V | First digit is 0. Second and third digits are significant figures of capacitance code. The fourth digit is the number of zeros following. Examples: 0101 = 100pF 0332 = 3300pF | M = ± 20% Z = -20+80% | C = COG/NP0 X = X7R | 0 = Without 1 = With |

Note: The addition of a 4-digit numerical suffix code can be used to denote changes to the standard part.

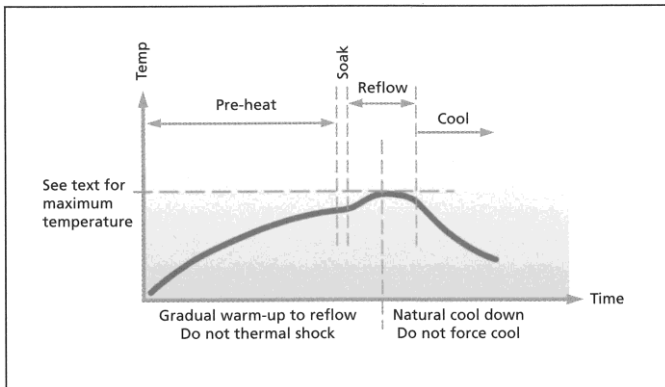
Options include for example: change of pin length / custom body dimensions or threads / alternative voltage rating / non-standard intermediate capacitance values / test requirements.

Please refer specific requests to the factory.

Surface Mount and Panel Mount Solder-in filters

Solder pad layouts are included with the detailed information for each part.

Recommended soldering profile



Soldering of filters

The soldering process should be controlled such that the filter does not experience any thermal shocks which may induce thermal cracks in the ceramic dielectric.

The pre-heat temperature rise of the filter should be kept to around 2°C per second. In practice successful temperature rises tend to be in the region of 1.5°C to 4°C per second dependent upon substrate and components.

The introduction of a soak after pre-heat can be useful as it allows temperature uniformity to be established across the substrate thus preventing substrate warping. The magnitude or direction of any warping may change on cooling imposing damaging stresses upon the filter.

E01, E03, E07 SBSP ranges are compatible with all standard solder types including lead-free, maximum temperature 260°C. For SBSG, SBSM and SFSS ranges, solder time should be minimised, and the temperature controlled to a maximum of 220°C. For SFSR, SFST and SFSU ranges the maximum temperature is 250°C.

Cooling to ambient temperature should be allowed to occur naturally. Natural cooling allows a gradual relaxation of thermal mismatch stresses in the solder joints. Draughts should be avoided. Forced air cooling can induce thermal breakage, and cleaning with cold fluids immediately after a soldering process may result in cracked filters.

Note: The use of FlexiCap™ terminations is strongly recommended to reduce the risk of mechanical cracking.

Soldering to axial wire leads

Soldering temperature

The tip temperature of the iron should not exceed 300°C.

Dwell time

Dwell time should be 3-5 seconds maximum to minimise the risk of cracking the capacitor due to thermal shock.

Heat sink

Where possible, a heat sink should be used between the solder joint and the body, especially if longer dwell times are required.

Bending or cropping of wire leads

Bending or cropping of the filter terminations should not be carried out within 4mm (0.157") of the epoxy encapsulation, the wire should be supported when cropping.

Soldering irons should not be used for mounting surface mount filters as they can result in thermal shock damage to the chip capacitor.

A more comprehensive application note covering installation of all Syfer products is available on the Syfer website.

Resin filled screw mounted EMI filters

General

The ceramic capacitor, which is the heart of the filter, can be damaged by thermal and mechanical shock, as well as by over-voltage. Care should be taken to minimise the risk of stress when mounting the filter to a panel and when soldering wire to the filter terminations.

Mounting to chassis

Mounting torque

It is important to mount the filter to the bulkhead or panel using the recommended mounting torque, otherwise damage may be caused to the capacitor due to distortion of the case. When a threaded hole is to be utilised, the maximum mounting torque should be 50% of the specified figure which relates to unthreaded holes. For details of torque figures for each filter range, please see below.

| Thread | Torque (max.) | |
|----------------------|---------------------|---------------------|
| | With nut | Into tapped hole |
| M2.5 & 4-40 UNC | - | 0.15Nm (1.32lbf in) |
| M3 | 0.25Nm (2.21lbf in) | 0.15Nm (1.32lbf in) |
| 6-32 UNC | 0.3Nm (2.65lbf in) | 0.15Nm (1.32lbf in) |
| M3.5 | 0.35Nm (3.09lbf in) | 0.18Nm (1.59lbf in) |
| M4 & 8-32 UNC | 0.5Nm (4.42lbf in) | 0.25Nm (2.21lbf in) |
| M5, 12-32 UNEF & 2BA | 0.6Nm (5.31lbf in) | 0.3Nm (2.65lbf in) |
| M6 & 1/4-28 UNF | 0.9Nm (7.97lbf in) | - |

Tools

Hexagonal devices should be assembled using a suitable socket. Round bodied filters may be fitted to the panel in one of two ways (and should not be fitted using pliers or other similar tools which may damage them):

- Round bodies with slotted tops are designed to be screwed in using a simple purpose-designed tool.
- Round bodies without slotted tops are intended to be inserted into slotted holes and retained with a nut.

Grounding

To ensure the proper operation of the filters, the filter body should be adequately grounded to the panel to allow an effective path for the interference. The use of locking adhesives is not recommended, but if used should be applied after the filter has been fitted.

Minimum plate thickness

Users should be aware that the majority of these filters have an undercut between the thread and the mounting flange of the body, equal to 1.5 x the pitch of the thread. Mounting into a panel thinner than this undercut length may result in problems with thread mating and filter position. It is recommended that a panel thicker than this undercut length be used wherever possible.

Maximum plate thickness

This is specified for each filter in order that the nut can be fully engaged even when using a washer.

Soldering to axial wire leads

Soldering temperature

The tip temperature of the iron should not exceed 300°C.

Dwell time

Dwell time should be 3-5 seconds maximum to minimise the risk of cracking the capacitor due to thermal shock.

Heat sink

Where possible, a heat sink should be used between the solder joint and the body, especially if longer dwell times are required.

Bending or cropping of wire leads

Bending or cropping of the filter terminations should not be carried out within 4mm (0.157") of the epoxy encapsulation, the wire should be supported when cropping.

RoHS compliance

All surface mount filters, resin sealed panel mount filters and power filters are fully RoHS compliant through material exemption, although care must be taken not to exceed the maximum soldering temperatures of surface mount parts.

Standard hermetic sealed panel mount filters use SnPb solders as part of their assembly, and are intended for exempt applications such as aerospace or military. Substitution of the SnPb solder with Pb free solders is possible to create a RoHS compliant part – please contact factory for further details.